32.768kHz SMD Crystal



Description

The ABS07N series is a tuning fork 32.768kHz quartz crystal offered in a 3.2mm x 1.5mm x 0.9mm two-pad SMD package. The ABS07N series offers industry standard frequency accuracy 0 +25°C±3°C (±20ppm), operating temperature range (-40°C to +85°C), load capacitance (CL), and Equivalent Series Resistance (ESR) electrical performance options that are commonly integrated into commercial and industrial end applications such as communication equipment, measuring equipment, and wireless devices.



Features

- Low frequency in small size SMD
- 0.9mm height ideal for high density circuit boards
- Seam sealed ceramic package offers excellent environmental & heat resistance
- REACH/RoHS II Compliant | MSL Level N/A

Typical Applications

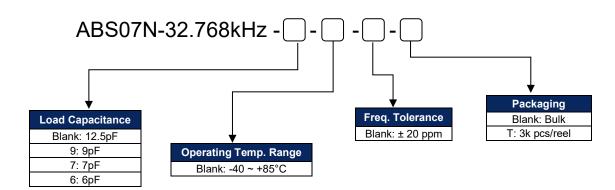
- Wide range in communication & measuring equipment
- Commercial & Industrial applications
- Wireless communications

Electrical Specifications

Parameters	Min.	Тур.	Max.	Units	Notes
Frequency		32.768		kHz	
Operation Mode	Flexural Mode (Tuning Fork)				
Operating Temperature Range	-40		+85	°C	
Storage Temperature Range	-40		+85	°C	
Frequency Tolerance @ +25°C±3°C	-20		+20	ppm	doesn't include aging
Temperature Coefficient			-0.040	ppm/C ²	
Turn-over Temperature	+20	+25	+30	°C	
Equivalent Series Resistance (R1)			40	kΩ	
Shunt capacitance (C0)			1.6	pF	
Load Capacitance (CL)		12.5		pF	See options
Drive Level		0.1	0.5	μW	
Aging (First year) @ +25°C	-3		+3	ppm	
Insulation Resistance	500			МΩ	@ 100Vdc ± 15V

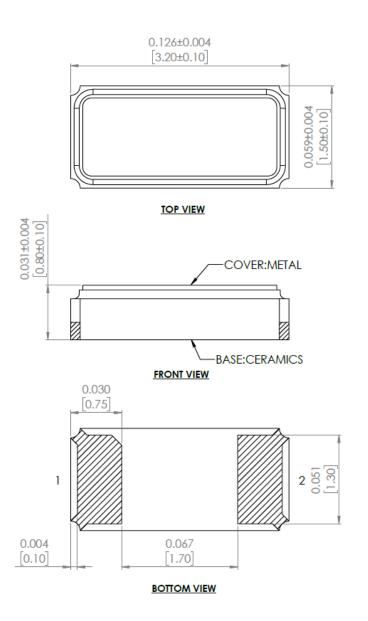


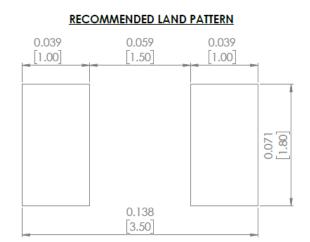
Part Identification





Mechanical Dimensions





Dimensions: inches [mm]



Reflow Profile [JEDEC J-STD-020]

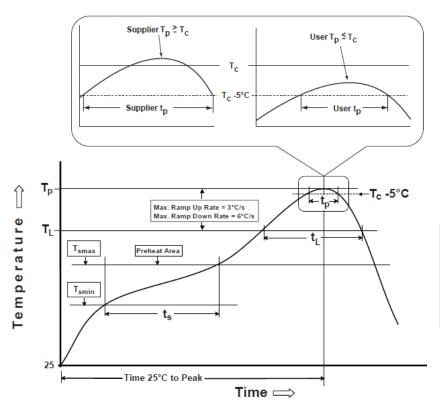


Table 1 **SnPb Eutectic Process** Classification Temperatures (Tc) Volume mm³ Package Volume mm³ <u>></u>350 Thickness <350 <2.5 mm 235 °C 220 °C ≥2.5 mm 220 °C 220 °C

Table 2							
Pb-Free Proc	ree Process						
Classification	Classification Temperatures (Tc)						
Package Thickness	Volume mm³ <350	Volume mm ³ 350-2000	Volume mm³ >2000				
<1.6 mm	260 °C	260 °C	260 °C				

250 °C

245 °C

245 °C

245 °C

260 °C

250 °C

1.6 mm - 2.5 mm

>2.5 mm

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat / soak		
Temperature minimum (T _{smin})	100°C	150°C
Temperature maximum (T _{smax})	150°C	200°C
Time (T _{smin} to T _{smax}) (t _s)	60 - 120 sec.	60 - 120 sec.
Average ramp-up rate (T _{smax} to T _P)	3°C/sec. max	3°C/sec. max
Liquidous temperature (T _L)	183°C	217°C
Time at liquidous (t _L)	60 - 150 sec.	60 - 150 sec.
Peak package body temperature (T _P)*	see Table 1	see Table 2
Time (t _p)** within 5°C of the specified classification temperature (T _C)	20 sec.	30 sec.
Ramp-down rate (T _p to T _{smax})	6°C/sec. max	6°C/sec. max
Time 25°C to peak temperature	6 min. max	8 min. max
Reflow cycles	2 max	2 max

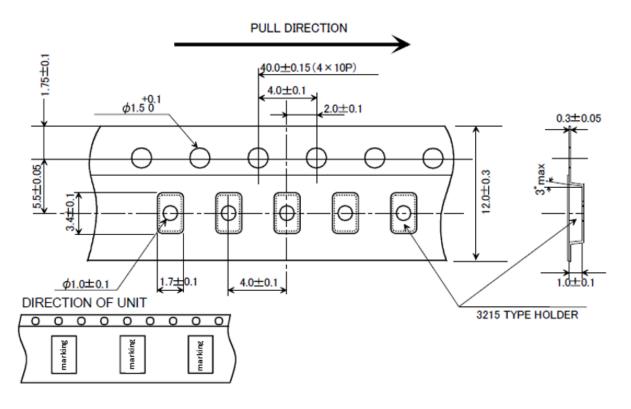
^{*}Tolerance for peak profile temperature (T_P) is defined as a supplier minimum and a user maximum.

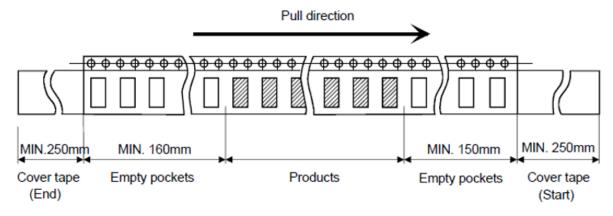
^{**}Tolerance for time at peak profile temperature (t_p) is defined as supplier minimum and a user maximum.



Packaging

T: Tape and reel (3,000pcs/reel)

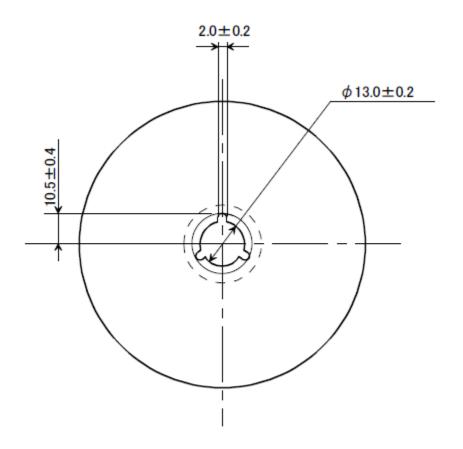


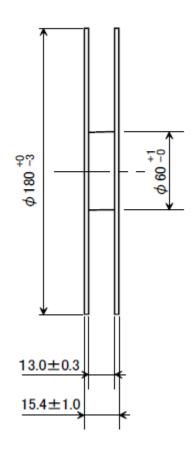


Dimensions: mm



Packaging continued





Dimensions: mm